

## **Technical Data Sheet**

Product Name:	0603-0.55T High Bright White LED
Part Number:	HQ19-2132UWC
Customer:	
Customer PN:	
Version:	A.2
Date:	2016.08.10

# Customer Approval

Instituted By:	Checked By:	Approved By:	
HARVA	ATEK OPTO-ELECTR	ONICS (SHENZHEN)	CO., LTD.

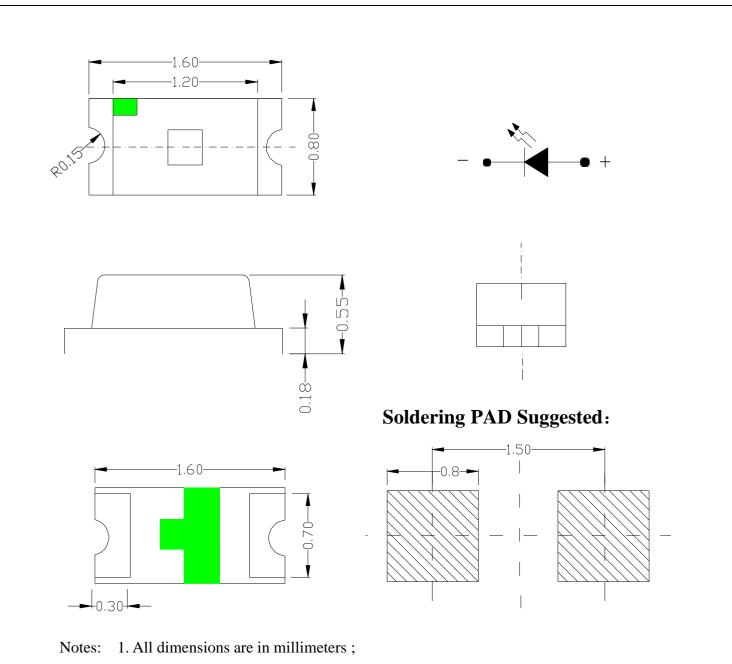


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### 1. Features

- Package ( L/W/H ) :  $1.6 \times 0.8 \times 0.55$  mm
- Color : Ultra High Bright White
- Lens: Yellow Diffuse Flat Mold
- EIA STD Package
- Meet ROHS, Green Product
- Compatible With SMT Automatic Equipment
- Compatible With Infrared Reflow Solder

### 2. Package Profile & Soldering PAD Suggested

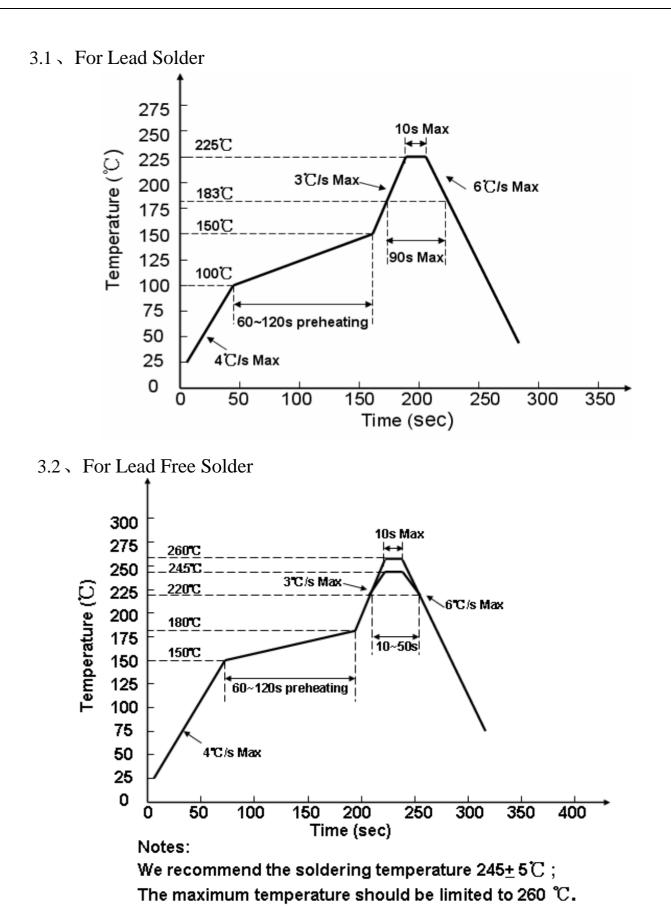


2. Tolerance is  $\pm 0.10$  mm unless otherwise noted.



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### 4. Absolute Maximum Ratings At Ta=25 °C

Parameter	Symbol	Rating	Unit	
Power Dissipation	Pd	75	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	Ifp	100	mA	
DC Forward Current	IF	25	mA	
Reverse Voltage	VR	5	V	
Operating Temperature Range	Topr	-30°C ~ +85°C		
Storage Temperature Range	Tstg	-40°C ~ +90°C		
Soldering Condition	Tsol	Reflow soldering : 260 °C For 5 Seconds Hand soldering: 300 °C For 3 Seconds		
Electrostatic Discharge	ESD	700	V	



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### 5. Electrical Optical Characteristics At Ta=25 °C

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Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV		450		mcd	IF = 5mA
Viewing Angle	201/2		120		deg	IF =5mA
CIE 1931 Coordinate	X/Y		X:0.26 Y:0.26		nm	IF=5mA
Forward Voltage	VF	2.7		3.2	V	IF=5mA
Color Temperature	ССТ	9000			K	IF=5mA
Reverse Current	IR			5	uA	VR=5V

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta 1/2$  is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda d$  is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

IV									
Bin			Min	M	lax	Uni	t	Cond	lition
N1			285		50				
N2			350	4	50				
P1			450	5	60	MCI	)	IF=:	5mA
P2			560	7	20	-			
Q1			720	9	00				
VF							~		
Bin 5D		<u>/Iin</u>		Max		Unit	Col	ndition	
5B 6A		2.7 2.8		2.8 2.9					
6B		2.8		3.0		V	IF	=5mA	
7A		3.0		3.1					
0.33 0.31 0.29 0.27 0.25 0.23		25	1 000K <b>Z1 A1</b>	10 4000K 22 15 12	800K Z3 B1 H A6 A7 A	B3 B4	B7 B8	> 	
				K	_				
0.21 <sup>l</sup>	73 0	04	0.25	0.26	0.97	0.00	0.20	 ^ 2	
	23 0	.24	0.25	0.26	0.27	0.28	0.29	0.3	



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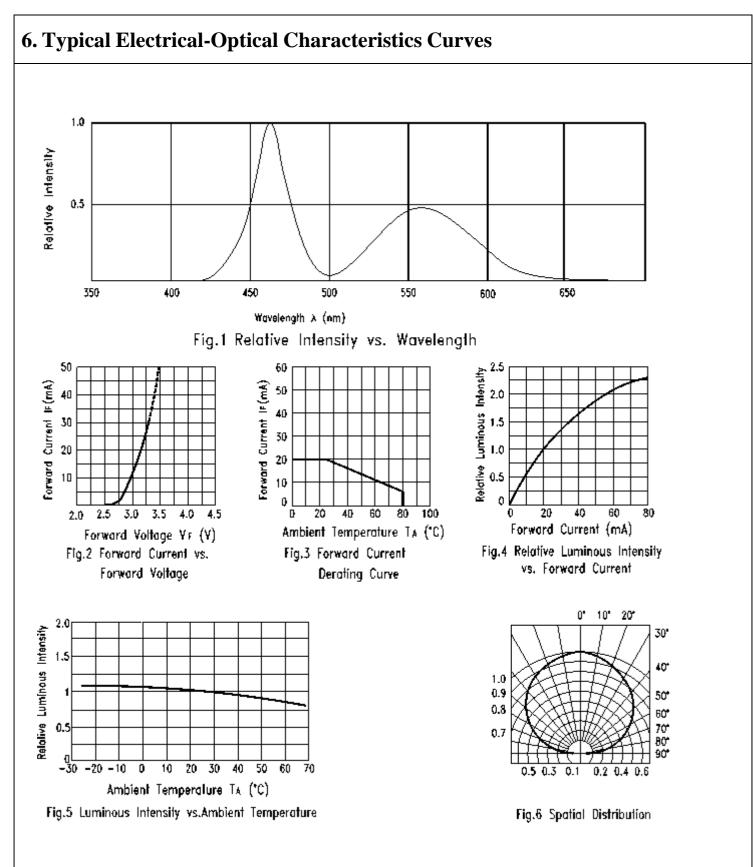
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Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y	Bin Code	CIE-X	CIE-Y
	0.2497	0.2267		0.2589	0.2445		0.26	0.271
A 1	0.245	0.229	٨G	0.2633	0.241	70	0.27	0.291
A1	0.2545	0.248	A6	0.272	0.2575	Z3	0.2735	0.286
	0.2589	0.2445		0.268	0.2623		0.264	0.267
	0.2497	0.2267		0.2677	0.2375		0.27	0.291
10	0.2589	0.2445	۸7	0.2633	0.241	74	0.28	0.311
A2	0.2633	0.241	Α7	0.272	0.2575	Z4	0.283	0.305
	0.2545	0.2245		0.276	0.2528		0.2735	0.286
	0.2593	0.2223		0.272	0.234	D1	0.264	0.267
4.2	0.2677	0.2375	A8 0. 2677 0. 276	0.2677	0.2375		0.268	0.2623
A3	0.2633	0.241		0.2528	B1	0.2772	0.28	
	0.2545	0.2245		0.28	0.248		0.2735	0.286
	0.264	0.22		0.24	0.231		0.272	0.2575
A 4	0.2593	0.2223	71	0.25	0.251	DО	0.268	0.2623
A4	0.2677	0.2375	Z1	0.2545	0.248	B2	0.2772	0.28
	0.272	0.234		0.245	0.2291		0.2808	0.274
	0.2545	0.248		0.25	0.251		0.272	0.2575
	0.2589	0.2445	79	0.26	0.271	00	0.276	0.2528
A5	0.268	0.2623	Z2	0.264	0.267	B3	0.2844	0.268
	0.264	0.267		0.2545	0.248		0.2808	0.274
	0.276	0.2528		0.2772	0.28		0.2844	0.268
D.4	0.2844	0.268	DC	0.2808	0.274	DO	0.2928	0.2833
B4	0.288	0.262	B6	0.2895	0.2905	B8	0.296	0.276
	0.28	0.248		0.2863	0.2978		0.288	0.262
	0.2735	0.286		0.2808	0.274			
DE	0.2772	0.28	$\mathbf{D7}$	0.2844	0.268			
В5	0.2863	0.2978	Β7	0.2928	0.2833			
	0.283	0.305		0.2895	0.2905			



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CAT

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### 7. Label Explanation

CAT: Luminous Intensity Rank (unit: mcd) HUE: CIE 1931 Coordinate Rank REF: Forward Voltage Rank (unit: V)

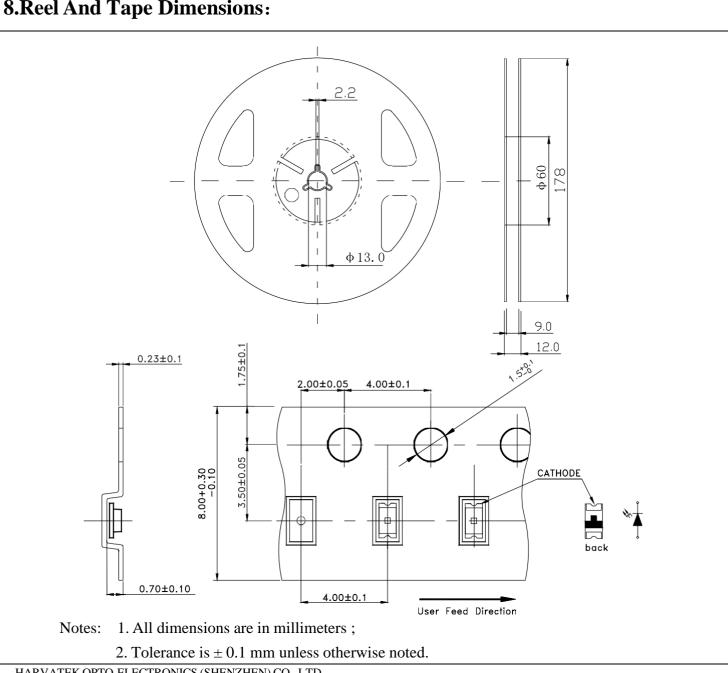
Rank Tolerance:

a. Luminous Intensity:  $\pm 11\%$ 

b. HUE: ±0.005

c. Forward Voltage:  $\pm 0.02V$ 

### 8.Reel And Tape Dimensions:

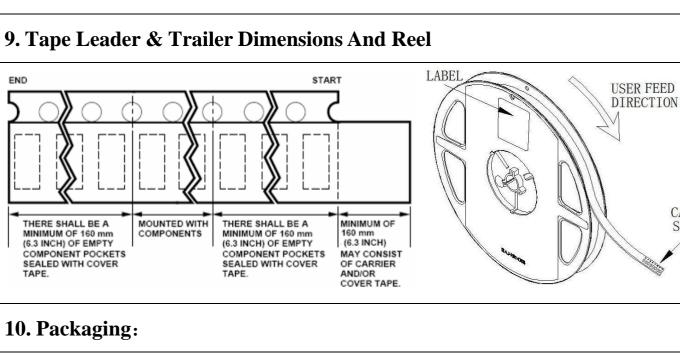


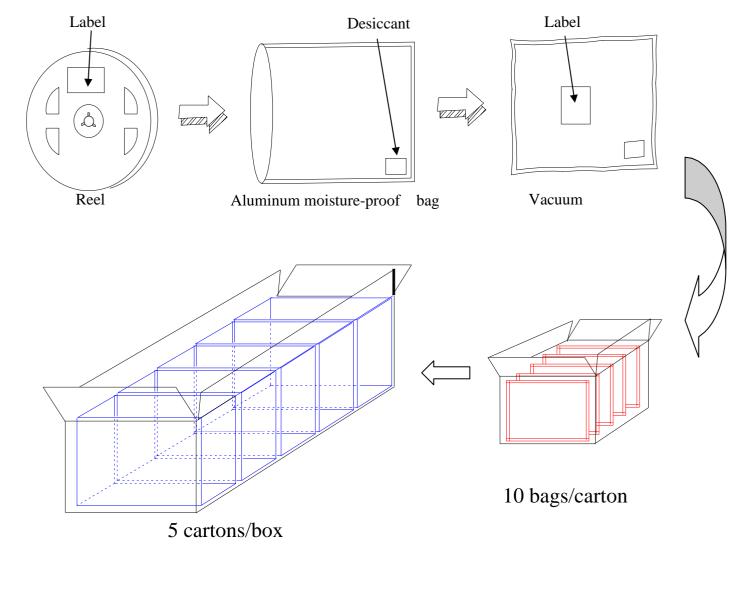


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### **11. Reliability Test**

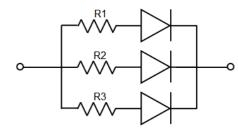
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Classification	Test Item	Test Condition	Reference Standard	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating	1000HRS (-24HRS,+72HRS)*@20mA	MIL-STD-750D:1026 MIL-STD-883D:1005 JIS C 7021:B-1
Endurance Test	High Temperature, High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 85±5℃,RH= 85%	1000HRS±2HRS	JESD22-A101
Test	High Temperature Storage	Ta= 105±5℃	1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 JIS C 7021:B-10
	Low Temperature Storage	Ta= -55±5 ℃	1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12
	Temperature Cycling	$105^{\circ}$ C ~ $25^{\circ}$ C ~ $-55^{\circ}$ C ~ $25^{\circ}$ C 30mins 5mins 30mins 5mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1010 JIS C 7021:A-4
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}$ C $\sim -40^{\circ}$ C $\pm 5^{\circ}$ C10mins10mins	10 Cycles	MIL-STD-202F:107D MIL-STD-750D:1051 MIL-STD-883D:1011
	Solder Resistance	$T.sol=260 \pm 5 \degree C$	$10 \pm 1 secs$	MIL-STD-202F:210A MIL-STD-750D:2031 JIS C 7021:A-1
Environmental Test	IR-Reflow Normal Process	Ramp-up rate(183°C to Peak) +3°C/ second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5/-0°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	IR-Reflow Pb Free Process	Ramp-up rate(217°C to Peak) +3°C/ second max Temp. maintain at 175(±25)°C 180 seconds max Temp. maintain above 217°C 60-150 seconds Peak temperature range 260°C+0/-5°C Time within 5°C of actual Peak Temperature (tp) 20-40 seconds Ramp-down rate +6°C/second max		MIL-STD-750D:2031.2 J-STD-020C
	Solderability	T.sol= $235 \pm 5$ °C Immersion rate $25\pm2.5$ mm/sec Coverage ≥95% of the dipped surface	Immersion time 2±0.5 sec	MIL-STD-202F:208D MIL-STD-750D:2026 MIL-STD-883D:2003 IEC 68 Part 2-20 JIS C 7021:A-2

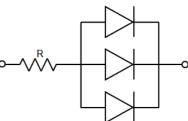


### 12. Cautions

### Application

- 1. A LED is a current-operated device. The slight shift of voltage will cause big change of current, which will damage LEDs. Customer should use resistors in series for the Over-Current-Proof.
- 2. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended to use individual resistor separately, as shown in Circuit A below. The brightness of each LED shown in Circuit B might appear difference due to the differences in the I-V characteristics of those LEDs.





Circuit model A

Circuit model B

- 3. High temperature may reduce LEDs' intensity and other performances, so keeping it away from heat source to get good performance is necessary.

### Storage

- 1. Before opening original package, it is recommended to store them in the following environment: Temperature:  $5^{\circ}C \sim 30^{\circ}C$ ; Humidity: 85% RH max. When the inventory over 2 months, Should be done before treatment using dehumidification, Temperature:  $60^{\circ}$ C/8 hours.
- 2. After opening original package, the storage ambient for the LEDs should be in 5~30°C temperature and 60% or less relative humidity.
- 3. In order to avoid moisture absorption, it is recommended that the LEDs that out of the original package should be stored in a sealed container with appropriate desiccant, or in desiccators with nitrogen ambient.
- 4. The LEDs should be used within 168hrs (7days) after opening the package. Once been mounted, soldering should be quick.
- 5. If the moisture absorbent material (silica gel) has faded away or the LEDs stored out of original package for more than 168hrs (7days), baking treatment should be performed using the conditions: 60°C at least 24 hours.

### ESD (Electrostatic Discharge )-Protection

A LED (especially the Blue, White and Green product) is an ESD sensitive component, and static electricity or power surge will damage the LED. ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light-up" at low currents, etc. Some advice as below should be noticed:



1. A conductive wrist strap or anti-electrostatic glove should be worn when handling these LEDs.

2. All devices, equipment, machinery, work tables and storage racks, etc. must be properly grounded

- (Grounding impedance value within  $10\Omega)\,$  .
- 3. Use anti-static package or boxes to carry and storage LEDs. And ordinary plastic package or boxes is forbidden to use.
- 4. Use ionizer to neutralize the static charge during handling or operating.
- 5. All surfaces and objects within 1 ft close to LEDs measure less than 100V.

### Cleaning

Use alcohol-based cleaning solvents such as IPA (isopropyl alcohol) to clean LEDs if necessary.

### Soldering

- 1. Soldering condition refer to the draft "Soldering Profile Suggested" on page 1.
- 2. Reflow soldering should not be done more than 2 times.
- 3. Manual soldering is only suggested on repair and rework. The maximum soldering temperature should not exceed 300°C within 3 sec. And the maximum capacity of soldering iron is 30W in power.
- 4. During the soldering process, do not touch the lens at high temperature.
- 5. After soldering, any mechanical force on the lens or any excessive vibration shall not be accepted to apply, also the circuit board shall not be bent as well.

### Others

- 1. The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Harvatek's Sales in advance for the applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health. (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).
- 2. The light output from the high luminous intensity LEDs may cause injury to human eyes when viewed directly.
- 3. The appearance and specifications of the product may be modified for improvement without prior notice.



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